



BAV199

DUAL SURFACE MOUNT LOW LEAKAGE DIODE

Features

Surface Mount Package Ideally Suited for Automatic Insertion

Very Low Leakage Current

Lead Free/RoHS Compliant (Note 3)

Mechanical Data

Case: SOT-23

Case Material: Molded Plastic. UL Flammability

Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020C

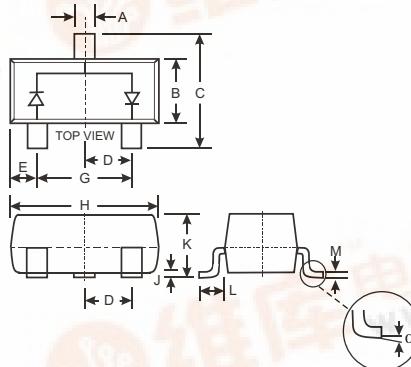
Terminals: Finish Matte Tin Solderable per MIL-STD-202, Method 208

Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).

Polarity: See Diagram

Marking: K52 & Date Code (See Page 2)

Weight: 0.008 grams (approximate)



SOT-23		
Dim	Min	Max
A	0.37	0.51
B	1.20	1.40
C	2.30	2.50
D	0.89	1.03
E	0.45	0.60
G	1.78	2.05
H	2.80	3.00
J	0.013	0.10
K	0.903	1.10
L	0.45	0.61
M	0.085	0.180
	0	8

All Dimensions in mm

Maximum Ratings @ $T_A = 25^\circ C$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		
Working Peak Reverse Voltage	V_{RWM}	85	V
DC Blocking Voltage	V_R		
RMS Reverse Voltage	$V_{R(RMS)}$	60	V
Forward Continuous Current (Note 2)	Single diode Double diode	I_{FM}	mA
Repetitive Peak Forward Current (Note 2)		I_{FRM}	mA
Non-Repetitive Peak Forward Surge Current @ $t = 1.0\text{ s}$ @ $t = 1.0\text{ms}$ @ $t = 1.0\text{s}$		I_{FSM}	A
Power Dissipation (Note 2)	P_d	250	mW
Thermal Resistance Junction to Ambient Air (Note 2)	R_{JA}	500	C/W
Operating and Storage Temperature Range	T_j, T_{STG}	-65 to +150	C

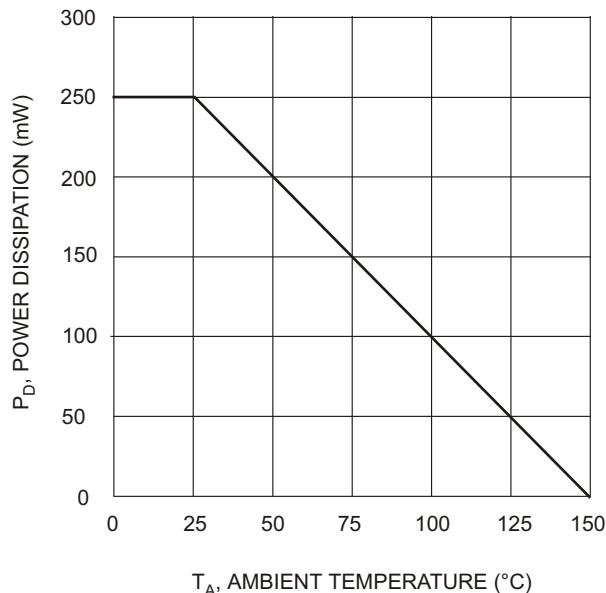
Electrical Characteristics @ $T_A = 25^\circ C$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	$V_{(BR)R}$	85			V	$I_R = 100\text{ A}$
Forward Voltage	V_F			0.90 1.0 1.1 1.25	V	$I_F = 1.0\text{mA}$ $I_F = 10\text{mA}$ $I_F = 50\text{mA}$ $I_F = 150\text{mA}$
Leakage Current (Note 1)	I_R			5.0 80	nA	$V_R = 75\text{V}$ $V_R = 75\text{V}, T_j = 150\text{ C}$
Total Capacitance	C_T		2		pF	$V_R = 0, f = 1.0\text{MHz}$
Reverse Recovery Time	t_{rr}			3.0	s	$I_F = I_R = 10\text{mA}$, $I_{rr} = 0.1 \times I_R, R_L = 100$

Notes: 1. Short duration test pulse to minimize self-heating effect.

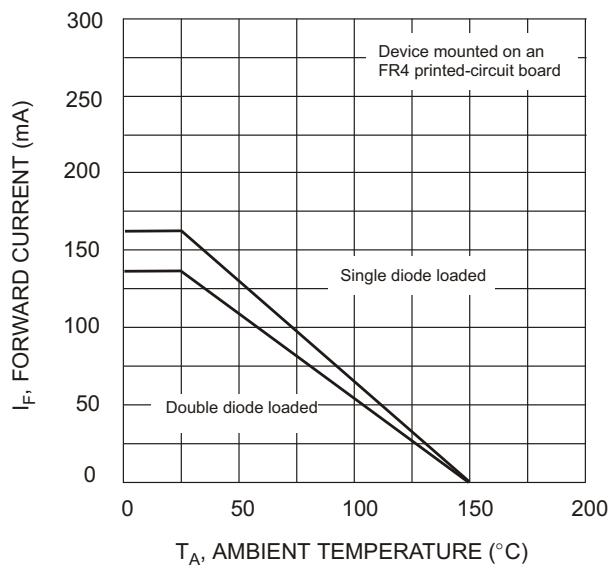
Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.

3. No purposefully added lead.



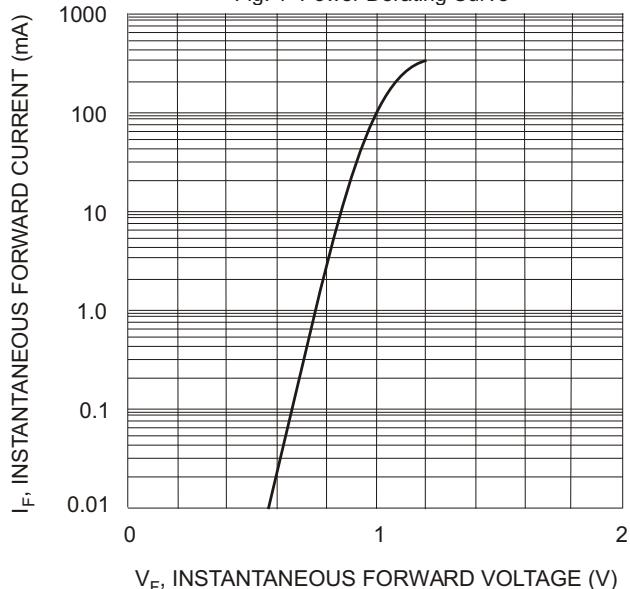
T_A, AMBIENT TEMPERATURE (°C)

Fig. 1 Power Derating Curve



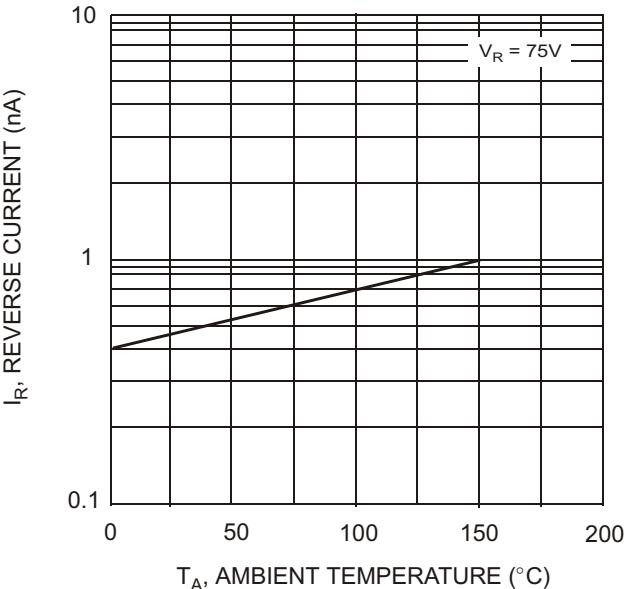
T_A, AMBIENT TEMPERATURE (°C)

Fig. 2 Current Derating Curve



V_F, INSTANTANEOUS FORWARD VOLTAGE (V)

Fig. 3 Typical Forward Characteristics



T_A, AMBIENT TEMPERATURE (°C)

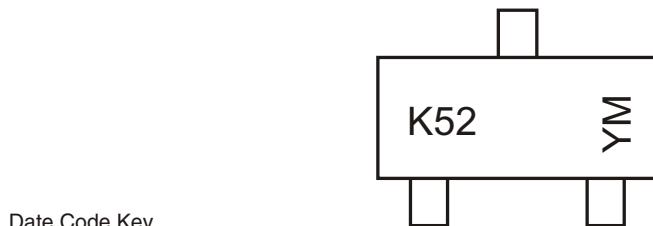
Fig. 4 Typical Reverse Characteristics

Ordering Information (Note 4)

Device	Packaging	Shipping
BAV199-7F	SOT-23	3000/Tape & Reel

Notes: 4. For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



Date Code Key

K52 = Product Type Marking Code
YM = Date Code Marking
Y = Year ex: N = 2002
M = Month ex: 9 = September

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	M	N	P	R	S	T	U	V	W	X	Y	Z

Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D



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